









INTERNATIONAL
SCIENCES, TECHNOLOGY
AND ENGINEERING
CONFERENCE

8th OCTOBER 2020

VENUE

Virtual Conference via Google Meet

Publication:

 All submitted paper will be reviewed by Editorial Board for consideration to be published in American Institute of Physics (AIP) and indexed by Scopus.
 Extended abstract (optional) with eISBN.

Topic:

Materials Science & Metallurgy
Materials Processing, Characterization and Forming
Nanomaterials: Synthesis and Characterization
Carbon Based Materials
Engineering and Structural Materials
Biomaterials
Materials for Optics
Textile Composites

Materials for Green Technology and Catalysis Semiconducting Materials Smart Materials & Advanced Functional Materials Ceramics, Composites & Glass Polymers Graphene

Conference Fees:

Category	Student	Non-Student
Local Presenter	MYR 600 (Oral /Poster presentation)	MYR 700
International Presenter	USD 180 (Oral /Poster presentation)	USD 220
Listener (Local)	MYR 55	
Listener (International)	USD 50	
Subsequent Manuscript	MYR 450 / USD 150	

Important Dates:

Deadline of registration & abstract submission
Deadline of Extended Abstract (optional)
Notification of acceptance
Payment and full manuscript submission
Conference day

: 10th July 2020

Thin Films

: 10th July 2020

: 2-3 days after abstract submission

: 7th August 2020

: 8th October 2020

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